

Application of the Grey-Box Modelling to Simulate GaN HEMTs

EAPPC-BEAMS-EML 2024

Ivan Vorotiahin, Martin Hergt, Marc Hiller, Martin Sack, and Georg Müller | September 26, 2024

Overview

1. [GaN HEMT](#page-2-0)

- **2. [Computational Method](#page-4-0)**
- **3. [Equivalent Circuit](#page-7-0)**
- **4. [Nonlinear Current Source Model](#page-9-0)**
- **5. [Conclusions](#page-17-0)**

GaN HEMT as a Pulsed Power Switch

Relevance for pulsed power switching:

- Short achievable rise time (down to 1 ns and less) (Sack et al. [2023\)](#page-0-0);
- Bidirectional operation;
- Achievable output voltages of up to 600 V. (Paraliev [2022\)](#page-0-0)

Typical structure of a GaN HEMT

Modelling Goals

Requirements for a behavioural model of a GaN HEMT:

- Obtainable by using results of standard S-parameter and double-pulse measurements as an input.
- Captures all operation regimes important for a particular application.
- **Model parameters can be traced back to quantifiable and measurable characteristics.**
- Augmentable with subcircuits for trapping effects.

Modelling Method

Measurements

Measurements provide a set of S-parameters

- Operating point: U_{qs} and U_{ds} are set using a DC and a pulse generators;
- \blacksquare Frequency is set at the NVA ports;
- Operating time (used to assess self-heating in the ON-state) is accounted for.

Computational process

■ The method was tested using I-V curves and S-parameters

- simulated with the manufacturer-supplied models for 3 devices,
- obtained from the characterization of a real device.
- Computations were made using MatLab libraries.
	- Grey-box estimation to obtain equivalent circuit component values,
	- Surface Fitting to obtain bias-dependent functions for variable components.
- Output data was represented as a SPICE sub-circuit.

Equivalent Circuits

 $\frac{\parallel C_{\rm{obs}}\parallel}{\parallel C_{\rm{obs}}\parallel}$ $\mathsf{H}_{\mathsf{C}_{\mathsf{opt}}}$ Intrinsisches Cate R_{ot} Modell Drain $\lceil c_{\textrm{\tiny{RMB}}}$ R Source Source

21 components: for frequencies up to 100 GHz.

15 components: for frequencies up to 500 MHz.

9 components: reducing degrees of freedom by removing negligible elements.

For each set OP, measured S-parameters are compared and iteratively fitted to parametric equations that describe the chosen equivalent circuit Sources: A. H. Jarndal [2006;](#page-0-0) Hergt [2021](#page-0-0)

Circuit Components

- \blacksquare Iterative computation yields component values corresponding to the measured set of operating points.
- Fitting to describe the corresponding components with bias-dependent functions.
- **The best fit is the 5th-order** polynomial, with different parameters for the passive regime and the active regime at high and low *Ugs*.

Nonlinear Current Source Model

Current-voltage characteristics can be described by the Chalmers equation (Angelov, Zirath, and Rosman [1992\)](#page-0-0):

$$
I_{ds} = I_{pk} \cdot \Big(1 + \tanh\Big(P_1\cdot (U_{gs}-U_{pk}) + P_2\cdot (U_{gs}-U_{pk})^2 + P_3\cdot (U_{gs}-U_{pk})^3\Big)\Big)\\ \cdot\tanh\left(\alpha_1\cdot U_{ds}\right)\cdot (1+\lambda U_{ds})\cdot (1-\Theta).
$$

10/19 26. 9. 2024 Ivan Vorotiahin *et al.*: Application of the Grey-Box Modelling to Simulate GaN HEMTs EAPPC 2024, Amsterdam

(1)

Current-Voltage Characteristics

Nonlinear Current Source Model

The assumption of the bell-shaped *G^m* is not fulfilled for the characterized transistors.

The first coefficient should become *I_S* in the ON state.

$$
I_{ds} = I_{pk} \frac{I_S}{I_{pks}} \cdot \left(1 + \tanh\left(P_1 \cdot (U_{gs} - U_{pk}) + P_2 \cdot (U_{gs} - U_{pk})^2 + P_3 \cdot (U_{gs} - U_{pk})^3\right)\right) \cdot \tanh(\alpha_1 \cdot U_{ds}) \cdot (1 + \lambda U_{ds}) \cdot (1 - \Theta).
$$

(2)

Current-Voltage Characteristics

Nonlinear Current Source Model

regime.

$$
I_{ds} = I_{pk} \frac{I_S}{I_{pks}} \cdot \left(1 + \tanh\left(P_1 \cdot (U_{gs} - U_{pk}) + P_2 \cdot (U_{gs} - U_{pk})^2 + P_3 \cdot (U_{gs} - U_{pk})^3\right)\right)
$$

 \cdot tanh $(\alpha_1 \cdot U_{ds} + \alpha_2 U_{ds}^2) \cdot (1 + \lambda U_{ds}) \cdot (1 - \Theta).$

 $\alpha_1 U_{ds}$ term is not enough to describe the curve slope in the ohmic regime. Expanding this term with $\alpha_2 U_{ds}^2$ allows describing G_{ds0} behaviour in this

(3)

Current-Voltage Characteristics

Finding Parameters Through Fitting

Instead of going through additional measurement and evaluation procedures in order to obtain the equation parameters, they can be found as fitting coefficients when using the modified Chalmers equation as a fit function for the measured IV-surface

Current-Voltage Characteristics

Fitting allows for more flexibility when the self-heating comes into play or if there are not enough measurement points to accurately find Chalmers equation parameters.

Conclusions

- **The method yields a model from a frequency- and bias-dependent set of S-parameters and I-V** characteristics.
- The obtained model can describe a GaN HEMT in the bias range of U_{ds} between 0 and 500 V, and all U_{qs} allowed by a data sheet, provided enough measured points, thus covering the pinch-off, the ohmic and the saturation regimes.
- **The parameter extraction process is based on widely-used equations for the equivalent circuit (e.g.,** A. Jarndal and Kompa [2006\)](#page-0-0) and the non-linear current source (e.g., Angelov, Zirath, and Rosman [1992\)](#page-0-0), modified for a specific device type.
- **Modelling provides suggestions about the distribution of the measured OPs.**
- **Possible extensions of the model include: improving of self-heating description, expansion to the** reversed-operation regime, explicit accounting for dispersive effects etc.

THANK YOU FOR YOUR ATTENTION!

Circuit Equations

Admittance matrix for the intrinsic part of the circuit at the n-th operating point:

$$
Y_{i}^{n} = \begin{pmatrix} \frac{G_{gs}^{n} + j\omega C_{gs}^{n}}{1 + R_{i}^{n}(G_{gs}^{n} + j\omega C_{gs}^{n})} + \frac{G_{gt}^{n} + j\omega C_{gt}^{n}}{1 + R_{gg}^{n}(G_{gt}^{n} + j\omega C_{gt}^{n})} & -\frac{G_{gt}^{n} + j\omega C_{gt}^{n}}{1 + R_{gg}^{n}(G_{gt}^{n} + j\omega C_{gt}^{n})} \\ \frac{G_{m}^{n}}{1 + R_{i}^{n}(G_{gs}^{n} + j\omega C_{gs}^{n})} - \frac{G_{gt}^{n} + j\omega C_{gt}^{n}}{1 + R_{gg}^{n}(G_{gt}^{n} + j\omega C_{gt}^{n})} & \frac{G_{gt}^{n} + j\omega C_{gt}^{n}}{1 + R_{gt}^{n}(G_{gt}^{n} + j\omega C_{gt}^{n})} + G_{ds}^{n} + j\omega C_{ds}^{n} \end{pmatrix} (4)
$$

External inductances as elements of a T-circuit are described with an impedance matrix:

$$
Z_{l}^{n} = \begin{pmatrix} Z_{i,11}^{n} + j\omega (L_{g}^{n} + L_{s}^{n}) & Z_{i,12}^{n} + j\omega L_{s}^{n} \\ Z_{i,21}^{n} + j\omega L_{s}^{n} & Z_{i,22}^{n} + j\omega (L_{d}^{n} + L_{s}^{n}) \end{pmatrix}
$$
(5)

External capacitances as elements of a Π-circuit are described with an admittance matrix:

$$
Y^{n} = \begin{pmatrix} Y_{l,11}^{n} + j\omega (C_{pgi}^{n} + C_{gdi}^{n}) & Y_{l,12}^{n} + j\omega C_{gdi}^{n} \\ Y_{l,21}^{n} + j\omega C_{gdi}^{n} & Y_{l,22}^{n} + j\omega C_{pdi}^{n} \end{pmatrix}
$$
(6)

Sources: A. H. Jarndal [2006;](#page-0-0) Hergt [2021](#page-0-0)

Drain and Gate Lag

